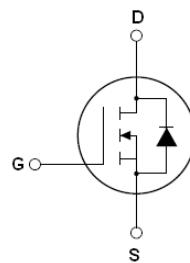


Features:

- Advanced trench process technology
- avalanche energy, 100% test
- Fully characterized avalanche voltage and current

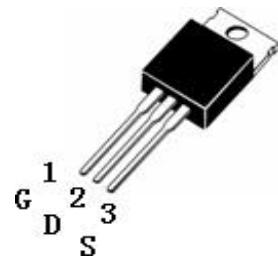
ID =60A
BV=60V
R_{dson}=14mΩ(max.)


Description:

The SSF6014 is a new generation of middle voltage and high current N-Channel enhancement mode trench power MOSFET. This new technology increases the device reliability and electrical parameter repeatability. SSF6014 is assembled in high reliability and qualified assembly house.

Application:

- Power switching application


SSF6014 TOP View (TO220)
Absolute Maximum Ratings

	Parameter	Max.	Units
I _D @T _c =25°C	Continuous drain current,V _{GS} @10V	60	A
I _D @T _c =100°C	Continuous drain current,V _{GS} @10V	42	
I _{DM}	Pulsed drain current ①	240	
P _D @T _c =25°C	Power dissipation	115	W
	Linear derating factor	0.74	W/C
V _{GS}	Gate-to-Source voltage	±20	V
E _{AS}	Single pulse avalanche energy ②	235	mJ
E _{AR}	Repetitive avalanche energy	TBD	
T _J	Operating Junction and		
T _{STG}	Storage Temperature Range	-55 to +175	C

Thermal Resistance

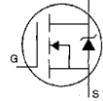
	Parameter	Min.	Typ.	Max.	Units
R _{θJC}	Junction-to-case	—	1.31	—	C/W
R _{θJA}	Junction-to-ambient	—	—	62	

Electrical Characteristics @T_J=25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
BV _{DSS}	Drain-to-Source breakdown voltage	60	—	—	V	V _{GS} =0V,I _D =250μA
R _{DS(on)}	Static Drain-to-Source on-resistance	—	12	14	mΩ	V _{GS} =10V,I _D =30A
V _{GS(th)}	Gate threshold voltage	2.0		4.0	V	V _{DS} =V _{GS} ,I _D =250μA
g _{fs}	Forward transconductance	—	60	—	S	V _{DS} =5V,I _D =30A
I _{DSS}	Drain-to-Source leakage current	—	—	2	μA	V _{DS} =60V,V _{GS} =0V
		—	—	10		V _{DS} =60V, V _{GS} =0V,T _J =150°C
I _{GSS}	Gate-to-Source forward leakage	—	—	100	nA	V _{GS} =20V
	Gate-to-Source reverse leakage	—	—	-100		V _{GS} =-20V

Q_g	Total gate charge	—	45	—	nC	$I_D=30A$ $V_{DD}=30V$ $V_{GS}=10V$
Q_{gs}	Gate-to-Source charge	—	4	—		
Q_{gd}	Gate-to-Drain("Miller") charge	—	15	—		
$t_{d(on)}$	Turn-on delay time	—	14.6	—	nS	$V_{DD}=30V$ $I_D=2A, R_L=15\Omega$ $R_G=2.5\Omega$ $V_{GS}=10V$
t_r	Rise time	—	14.2	—		
$t_{d(off)}$	Turn-Off delay time	—	40	—		
t_f	Fall time	—	7.3	—		
C_{iss}	Input capacitance	—	1480	—	pF	$V_{GS}=0V$ $V_{DS}=25V$ $f=1.0MHz$
C_{oss}	Output capacitance	—	190	—		
C_{rss}	Reverse transfer capacitance	—	135	—		

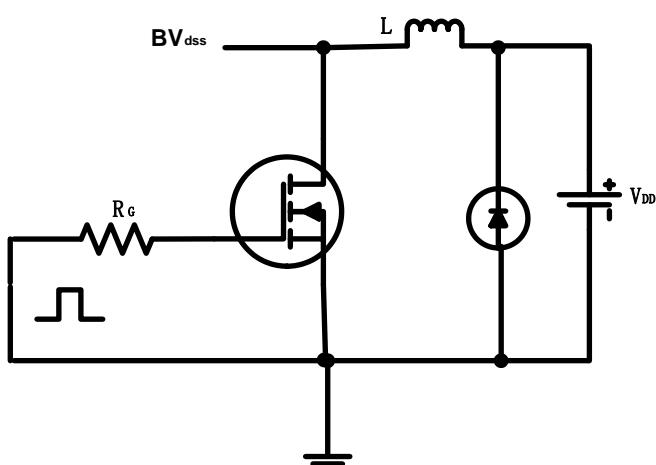
Source-Drain Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
I_S	Continuous Source Current (Body Diode)	—	—	60	A	MOSFET symbol showing the integral reverse p-n junction diode. 
I_{SM}	Pulsed Source Current (Body Diode) ①	—	—	240		
V_{SD}	Diode Forward Voltage	—	—	1.3	V	$T_J=25C, I_S=40A, V_{GS}=0V$ ③
t_{rr}	Reverse Recovery Time	—	33	—	nS	$T_J=25C, I_F=60A$ $di/dt=100A/\mu s$ ③
Q_{rr}	Reverse Recovery Charge	—	61	—	nC	
t_{on}	Forward Turn-on Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_s + LD$)				

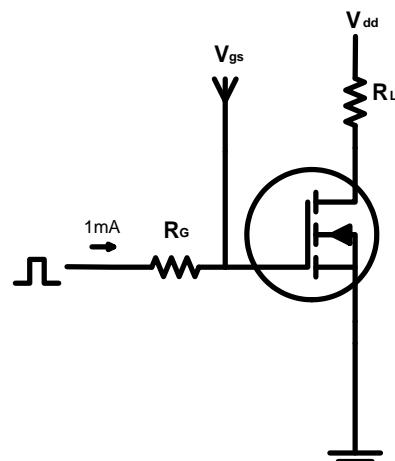
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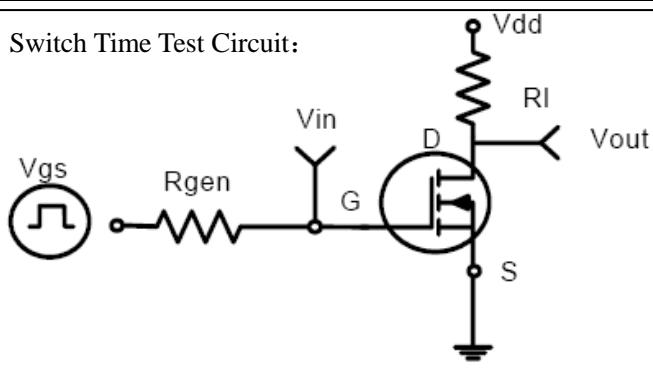
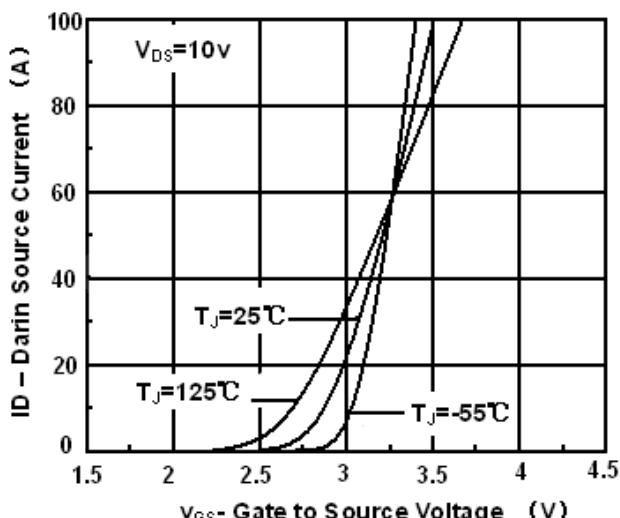
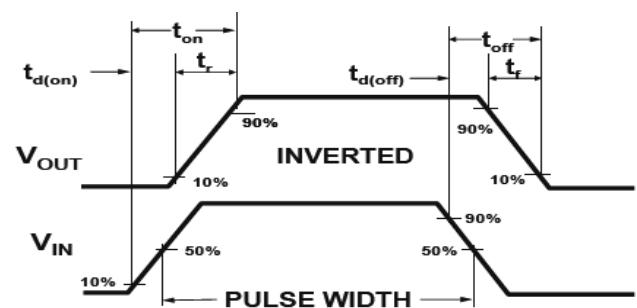
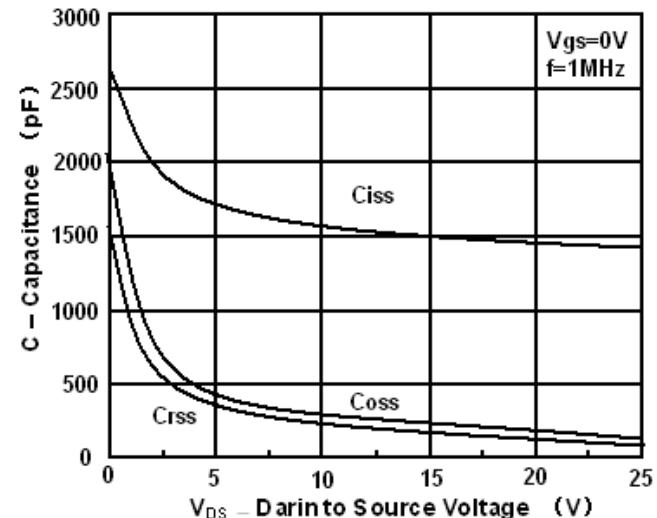
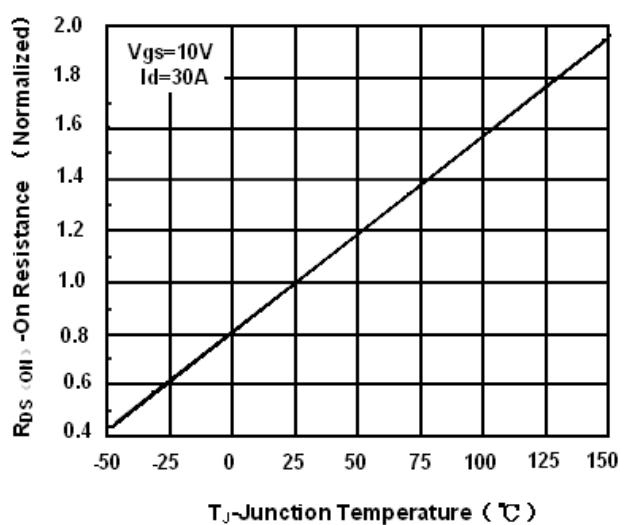
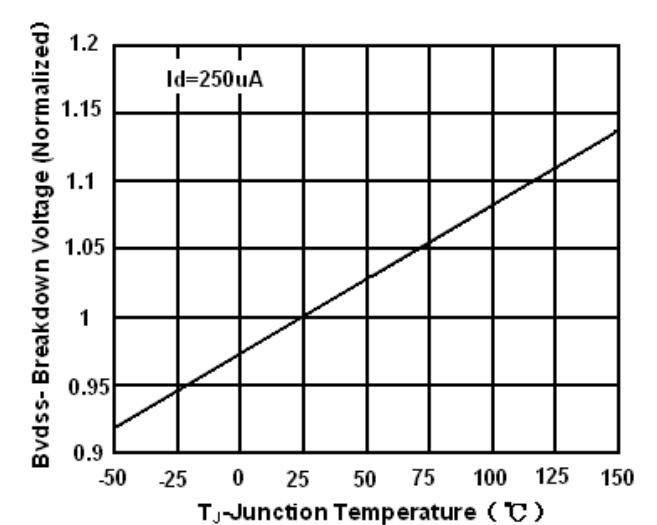
- ① Repetitive rating; pulse width limited by max junction temperature.
- ② Test condition: $L = 0.3mH$, $V_{DD} = 30V$, $I_D = 37A$
- ③ Pulse width $\leq 300\mu s$, duty cycles $\leq 1.5\%$; $R_G = 25\Omega$ Starting $T_J = 25^\circ C$

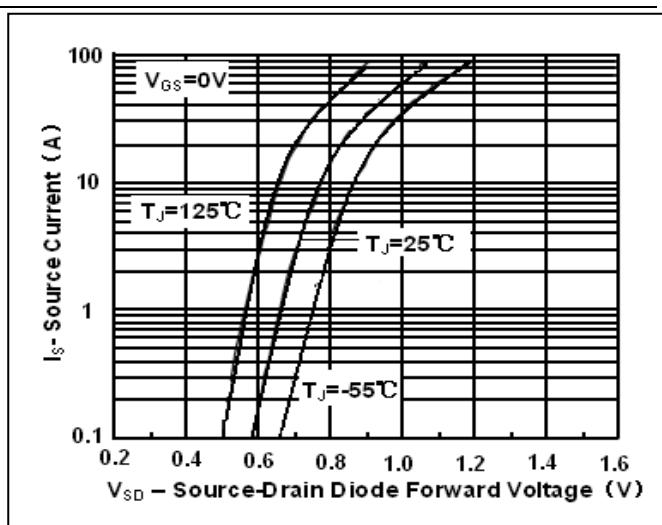
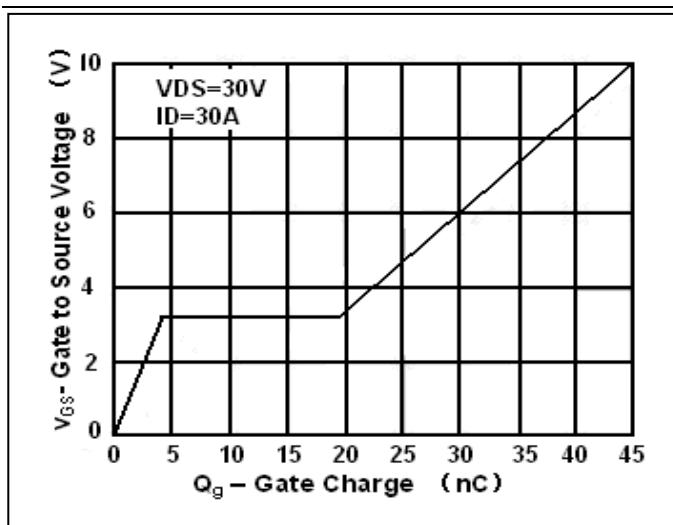
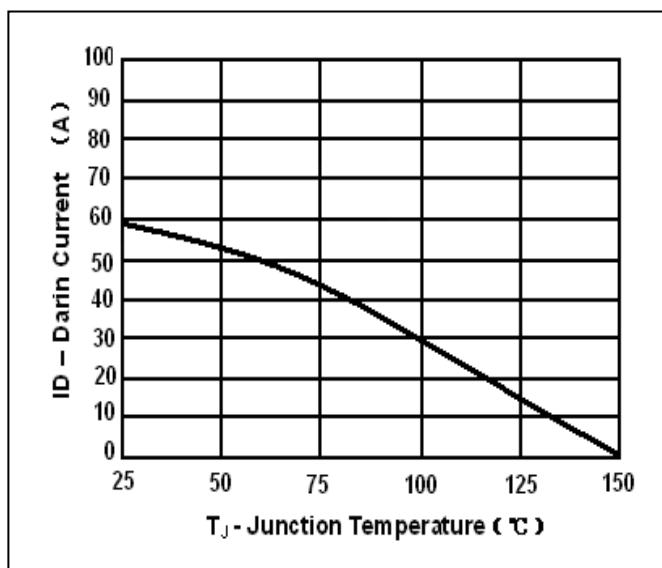
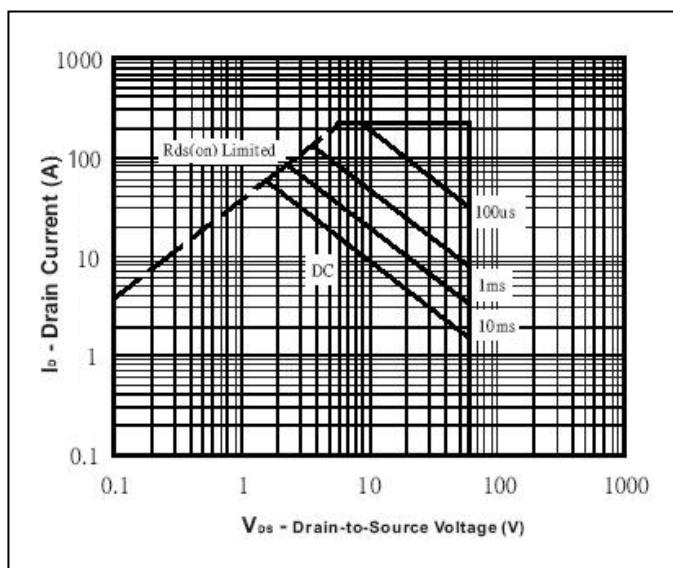
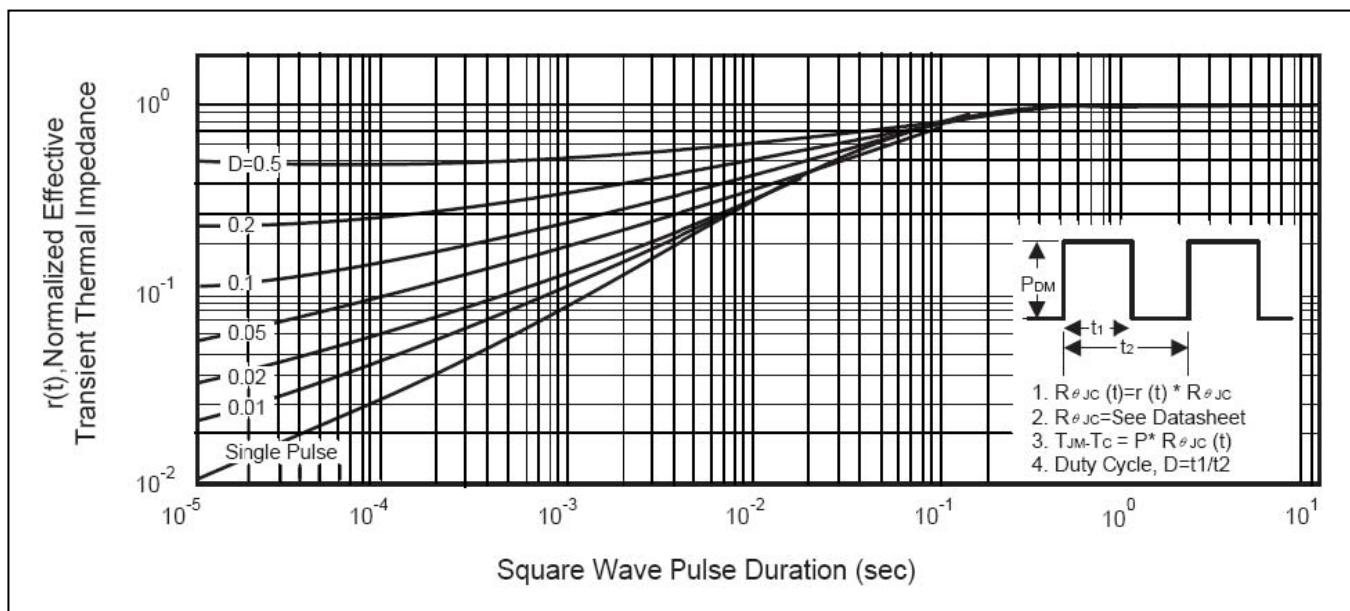
EAS test circuit:

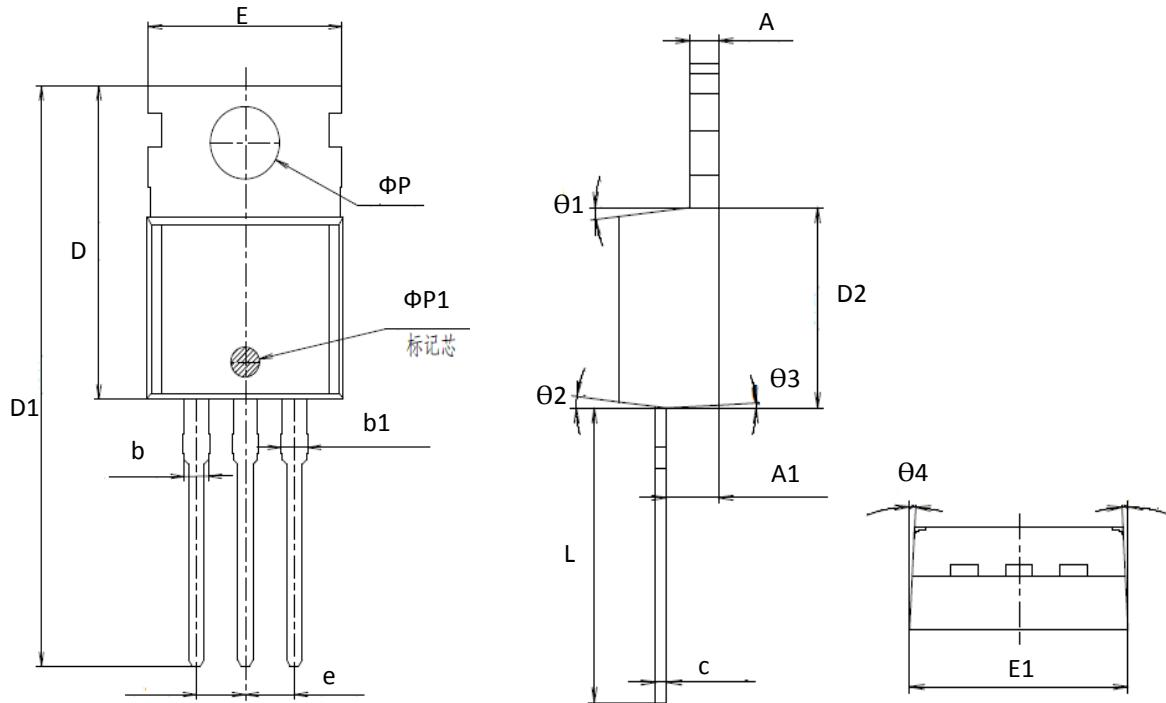


Gate charge test circuit:



Switch Time Test Circuit:

Switch Waveforms:

Transfer Characteristic

Capacitance

On Resistance vs. Junction Temperature

Breakdown Voltage vs. Junction Temperature


Gate Charge
Source-Drain Diode Forward Voltage

Safe Operation Area
Max Drain Current vs. Junction Temperature

Transient Thermal Impedance Curve

MECHANICAL DATA:
TO220 PACKAGE OUTLINE DIMENSION_GN


Symbol	Dimension In Millimeters			Dimension In Inches		
	Min	Nom	Max	Min	Nom	Max
A	-	1.300	-	-	0.051	-
A1	2.200	2.400	2.600	0.087	0.094	0.102
b	-	1.270	-	-	0.050	-
b1	1.270	1.370	1.470	0.050	0.054	0.058
c	-	0.500	-	-	0.020	-
D	-	15.600	-	-	0.614	-
D1	-	28.700	-	-	1.130	-
D2	-	9.150	-	-	0.360	-
E	9.900	10.000	10.100	0.390	0.394	0.398
E1	-	10.160	-	-	0.400	-
ΦP	-	3.600	-	-	0.142	-
ΦP1		1.500			0.059	
e	2.54BSC			0.1BSC		
L	12.900	13.100	13.300	0.508	0.516	0.524
Θ1	-	7°	-	-	7°	-
Θ2	-	7°	-	-	7°	-
Θ3	-	3°	-	5°	7°	9°
Θ4	-	3°	-	1°	3°	5°